

# Contents

<b>1</b>	<b>The Cathodic Polarization Curves in Electrodeposition of Metals . . . . .</b>	<b>1</b>
1.1	Introduction . . . . .	1
1.2	Polarization Curves for the Case of Massive Active Cathodes . . . . .	2
1.2.1	Polarization Curves Without Included Ohmic Potential Drop . . . . .	2
1.2.2	Polarization Curves with Included Ohmic Potential Drop . . . . .	10
1.3	Experimental Measured Polarization Curves . . . . .	13
1.3.1	Polarization Curves for the Different Kinds of the Electrodeposition Process Control . . . . .	13
1.3.2	Polarization Curves Measured for Different $i_0/i_L$ Ratios . . . . .	20
	References . . . . .	21
<b>2</b>	<b>Mechanisms of Formation of Some Forms of Electrodeposited Pure Metals . . . . .</b>	<b>25</b>
2.1	Electrodeposition on Native Substrate . . . . .	25
2.1.1	Macroelectrodes and Microelectrodes . . . . .	25
2.1.2	Active Microelectrodes Placed Inside Diffusion Layer of the Active Macroelectrode . . . . .	27
2.1.3	Dendritic Deposits . . . . .	39
2.2	Electrodeposition on the Inert Substrate . . . . .	55
2.2.1	Cementation and Prevention of it by Deposition from the Complex Salt Solutions . . . . .	55
2.2.2	Surface Film Formation . . . . .	55
2.2.3	Active Microelectrodes Inside the Diffusion Layer of the Inert Macroelectrode . . . . .	83

2.2.4	Dendritic Growth Initiation Inside Diffusion Layer of the Macroelectrode in the Case of Very Fast Electrodeposition Processes . . . . .	90
2.2.5	Spongy Deposit Formation . . . . .	94
2.2.6	Whisker Deposits . . . . .	101
	References . . . . .	103
<b>3</b>	<b>Current Distribution in Electrochemical Cells . . . . .</b>	<b>111</b>
3.1	Introduction . . . . .	111
3.2	The Current Density Distribution in Homogeneous Fields . . . . .	112
3.3	The Edge Effect . . . . .	114
3.4	Two Equal Plane Parallel Electrode Arrangement . . . . .	115
3.4.1	Ohmic Resistance of the Cell . . . . .	115
3.4.2	The Very Edge Ohmic Resistance . . . . .	118
3.4.3	The Quantitative Consideration of the Edge Effect . . . . .	119
3.4.4	The Depth of the Penetration of a Current Line Between the Electrode Edges and the Cell Side Walls . . . . .	120
3.4.5	The Critical Current Density for Dendritic Growth Initiation at the Edges . . . . .	126
3.4.6	Cells with Low Anode Polarization . . . . .	127
3.4.7	Corner Weakness Phenomena in Electroforming . . . . .	134
	References . . . . .	138
<b>4</b>	<b>Electrodeposition at a Periodically Changing Rate . . . . .</b>	<b>141</b>
4.1	Introduction . . . . .	141
4.1.1	Reversing Current . . . . .	141
4.1.2	Pulsating Current . . . . .	143
4.1.3	Alternating Current Superimposed on Direct Current . . . . .	143
4.1.4	Pulsating Overpotential . . . . .	144
4.1.5	Reversing Overpotential . . . . .	144
4.2	Surface Concentration of Depositing Ions in the Periodic Conditions . . . . .	144
4.2.1	Electrodeposition with Periodically Changing Range in the Millisecond Range . . . . .	144
4.2.2	Capacitance Effects . . . . .	149
4.2.3	Reversing Current in the Second Range . . . . .	150
4.3	Prevention of the Formation of Spongy Deposits and the Effect on Dendritic Particles . . . . .	152
4.3.1	Basic Facts . . . . .	152
4.3.2	Quantitative Treatment . . . . .	154
4.4	Compact Deposits . . . . .	158
4.4.1	Surface Film . . . . .	158
4.4.2	Electrode Surface Coarsening . . . . .	160
4.5	Current Density and Morphology Distribution on a Macropile . . . . .	164
	References . . . . .	167

<b>5 Electrodeposition of Metals with Hydrogen Evolution . . . . .</b>	<b>171</b>
5.1 Introduction . . . . .	171
5.2 Mechanism of Formation of the Honeycomb-Like Structure: The Concept of “Effective Overpotential” . . . . .	173
5.2.1 The Concept of “Effective Overpotential” Applied for Metal Electrodeposition Under an Imposed Magnetic Field . . . . .	175
5.3 The Honeycomb-Like Structures: Basic Facts, Phenomenology, and Factors Affecting Their Formation (Cu as a Model System) . . . . .	176
5.3.1 Basic Facts . . . . .	176
5.3.2 Phenomenology of Formation of the Honeycomb-Like Structures . . . . .	178
5.3.3 Factors Affecting the Size and Distribution of Holes in the Honeycomb-Like Structures . . . . .	179
5.4 Effect of Additives on Micro- and Nanostructural Characteristics of the 3D Foam or the Honeycomb-Like Electrodes . . . . .	182
5.5 Structural Characteristics of the 3D Foam or the Honeycomb-Like Structures of the Other Metals . . . . .	183
5.5.1 The Honeycomb-Like or 3D Foam Structures of the Normal Metals . . . . .	184
5.5.2 The Honeycomb-Like or 3D Foam Structures of the Intermediate Metals . . . . .	185
5.5.3 The Honeycomb-Like or 3D Foam Structures of the Inert Metals . . . . .	187
5.6 Application of Periodically Changing Regimes of Electrolysis on Metal Electrodeposition in the Hydrogen Evolution Range . . . . .	187
5.6.1 The Regime of Pulsating Overpotential in the Hydrogen Evolution Range: Optimization of Formation of the Honeycomb-Like Electrodes . . . . .	190
5.6.2 The Pulsating Current in the Hydrogen Evolution Range . . . . .	193
5.6.3 The Reversing Current in the Hydrogen Evolution Range . . . . .	196
5.6.4 Comparison of the Honeycomb-Like Structures Obtained by the Galvanostatic and the Reversing Current Regimes . . . . .	199
References . . . . .	200

<b>6</b>	<b>Electrochemically Produced Metal Powders . . . . .</b>	<b>205</b>
6.1	Introduction . . . . .	205
6.2	Morphology of Powder Particles in the Dependence of the Exchange Current Density and Hydrogen Overpotential . . . . .	206
6.2.1	Class I: So-Called Normal Metals . . . . .	206
6.2.2	Class II: Intermediate Metals . . . . .	208
6.2.3	Class III: Inert Metals . . . . .	209
6.3	The Characteristics of Electrochemically Produced Powder: A General Discussion . . . . .	210
6.4	Application of Periodically Changing Regimes of Electrolysis on Formation of Metal Powders . . . . .	214
6.5	Analysis of Decisive Properties of Powders and Their Mutual Relations . . . . .	215
6.5.1	Correlation Between Specific Surface and Overpotential of Electrodeposition . . . . .	216
6.5.2	The Apparent Density as a Function of Specific Surface and Overpotential of the Electrodeposition . . . . .	221
6.5.3	The Size of Representative Particle and Particle Size Distribution . . . . .	222
6.5.4	The Effect of the Particle Shape and Structure on the Flowability of Electrolytic Copper Powder . . . . .	227
	References . . . . .	229
<b>7</b>	<b>Electrodeposited Alloys and Multilayered Structures . . . . .</b>	<b>233</b>
7.1	Introduction . . . . .	233
7.2	Electrodeposition of Alloys from Aqueous Solutions . . . . .	234
7.2.1	Conditions for Electrodeposition of Alloys . . . . .	234
7.2.2	Types of Electrodeposition of Alloys . . . . .	237
7.2.3	Specific Structural Phenomena in Electrodeposition of Alloys . . . . .	262
7.2.4	Electrodeposition of Alloys with Periodically Changing Currents . . . . .	264
7.3	Multilayered Structures . . . . .	267
7.3.1	Introduction . . . . .	267
7.3.2	Electrodeposition of Laminar Metal Structures . . . . .	268
	References . . . . .	286
<b>8</b>	<b>Electrodeposited Alloy Powders . . . . .</b>	<b>291</b>
8.1	Introduction . . . . .	291
8.2	Anomalous Codeposition of Alloy Powders . . . . .	292
8.2.1	Electrodeposited Co-Ni Powders . . . . .	292
8.2.2	Electrodeposited Fe-Ni Alloy Powders . . . . .	305
8.3	Induced Codeposition of Alloy Powders . . . . .	316
8.3.1	Electrodeposited Mo-Ni-O Powders . . . . .	316
	References . . . . .	326

<b>9 Chemical Deposition of Metals and Alloys from Aqueous Solutions . . . . .</b>	<b>329</b>
9.1 Introduction . . . . .	329
9.2 Types of Chemical Deposition of Metals from Aqueous Solutions . . . . .	330
9.2.1 Galvanic Displacement Deposition . . . . .	330
9.2.2 Autocatalytic Deposition . . . . .	352
References . . . . .	363
<b>Index . . . . .</b>	<b>365</b>

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